



FOR : BE SEMICONDUCTOR INDUSTRIES N.V.
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PRESS RELEASE

BE Semiconductor Industries Announces 2010 Second Quarter Results Release and Conference Call and Webcast Date

Duiven, the Netherlands, July 19, 2010, BE Semiconductor Industries N.V. ("Beside") (Euronext: BESI), a leading manufacturer of assembly equipment for the semiconductor industry, will release results for the second quarter ended June 30, 2010, on Tuesday July 27, 2010 at 8.00 a.m. Continental European Time (2.00 a.m. New York time).

Beside will host a conference call and audio webcast (log on via www.besi.com) to discuss its results for the second quarter ended June 30, 2010, on Tuesday July 27, 2010 at **4.00 p.m. CET** (10.00 a.m. New York time). The teleconference dial-in number is (31) 10 2944 228. The audio webcast will remain available on www.besi.com.

About Beside

Beside is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries. Beside develops leading edge assembly processes and equipment for leadframe, array connect and wafer level packaging applications in a wide range of end-use markets including electronics, computer, automotive, industrial, RFID, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Beside's ordinary shares are listed on NYSE Euronext Amsterdam (symbol: BESI) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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